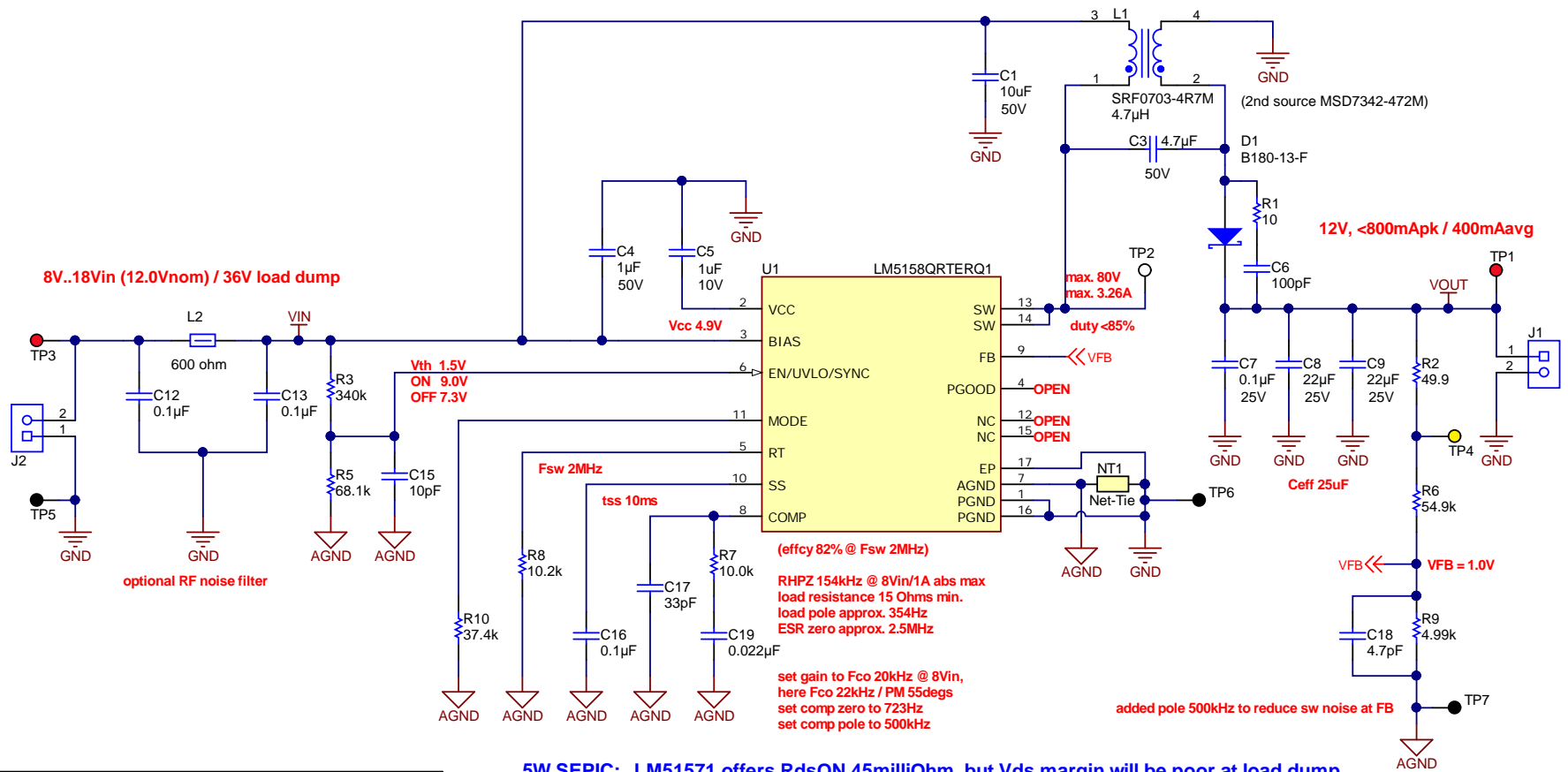


Dual Inductor L1 2x 4.7uH:
 core material T2, MeFe2O4, Me = Zn 15% / Cu 17% / Mn 16%
 (at Fsw 2MHz use FERRITE core material)



5W SEPIC: LM51571 offers RdsON 45milliOhm, but Vds margin will be poor at load dump
dynamic load specifications, loop designed for maximum bandwidth

Design Notes:
 - R2 for test purpose only

Revision History	
Revision	Notes
A	PRELIMINARY, designed for small size LAYOUT, removed R14 and C14
A1	EP to GND, R5 and C15 to AGND
A2	L1: Pin 1 to switchnode added R10 37k4 in between MODE and AGND tuned loop (reduced gain by -6dB)

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Number: PMP31139 | Rev: A2
 SVN Rev: Version control disabled
 Drawn By:
 Engineer: B.Geck

Designed for: Public Release | Mod. Date: 2/11/2022
 Project Title: Tiny Automotive SEPIC using 80V Integrated FET
 Sheet Title: PMP31139_RevA1
 Assembly Variant: [No Variations] | Sheet: 1 of 1
 File: PMP31139RevA2_Schematic.SchDoc | Size: A4
 Contact: <http://www.ti.com/support>



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